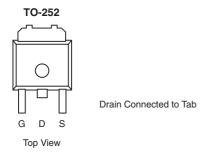


N-Channel 25-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A) ^{a, e}	Q _g (Typ)			
25	0.0062 at V _{GS} = 10 V	78	20.5 nC			
25	0.010 at V _{GS} = 4.5 V	62	20.5 110			



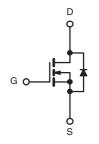
FEATURES

- TrenchFET® Power MOSFET
- 100 % R_a Tested
- RoHS Compliant



APPLICATIONS

- DC/DC Conversion, Low-Side
 - Desktop PC



N-Channel MOSFET

Ordering Information: SUD50N025-06P-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS	S T _A = 25 °C, unle	ess otherwise n	noted	
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	25	V	
Gate-Source Voltage	V _{GS}	± 20	v	
	T _C = 25 °C		78 ^{a, e}	
Continuous Drain Current (T. – 175 °C)	T _C = 70 °C	[65 ^{a, e}	7
Continuous Drain Current (T _J = 175 °C)	T _A = 25 °C	I _D	32 ^{b, c}	
	T _A = 70 °C		25 ^{b, c}	A
Pulsed Drain Current	I _{DM}	100		
0 " 0 5 " 5" 1 0 .	T _C = 25 °C	,	43	7
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	7.1 ^{b, c}	
Avalanche Current Pulse		I _{AS}	35	
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	61.25	mJ
	T _C = 25 °C		65 ^a	
Maximum Power Dissipation	T _C = 70 °C	_ [45 ^a	w
	T _A = 25 °C	P _D	10.7 ^{b, c}	vv
	T _A = 70 °C		7.5 ^{b, c}	
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 sec	R_{thJA}	11	14	°C/W		
Maximum Junction-to-Case	Steady State	R _{thJC}	1.9	2.3] C/VV		

Notes:

- Notes:
 a. Based on T_C = 25 °C.
 b. Surface Mounted on 1" x 1" FR4 board.
 c. t = 10 sec.
 d. Maximum under Steady State conditions is 90 °C/W.
 e. Calculated based on maximum junction temperature. Package limitation current is 50 A.

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SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	25			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		20		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1 _D = 230 μΛ		- 5.5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.4		2.4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zara Cata Valtaga Drain Current	lasa	V _{DS} = 25 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
David Course On Olate Basistana 3	r	V _{GS} = 10 V, I _D = 20 A		0.0051	0.0062	0.0062 0.010 Ω	
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 4.5 V, I _D = 15 A		0.0081	0.010		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		55		S	
Dynamic ^b							
Input Capacitance	C _{iss}			2490			
Output Capacitance	C _{oss}	$V_{DS} = 12 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		530		pF	
Reverse Transfer Capacitance	C _{rss}			280			
Total Gate Charge		$V_{DS} = 12 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$		44 6	66	nC	
				20.5	31		
Gate-Source Charge	Q_{gs}	$V_{DS} = 12 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 50 \text{ A}$		7.5			
Gate-Drain Charge	Q_{gd}			7.0			
Gate Resistance	R_{g}	f = 1 MHz	0.55	1.1	1.65	Ω	
Turn-On Delay Time	t _{d(on)}			19	28		
Rise Time	t _r	$V_{DD} = 12 \text{ V}, R_{L} = 0.24 \Omega$		12	18		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		18	27		
Fall Time	t _f			7	11	no	
Turn-On Delay Time	t _{d(on)}			9	14	ns	
Rise Time	t _r	$V_{DD} = 12 \text{ V}, R_{L} = 0.24 \Omega$		11	16.5		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		24	36		
Fall Time	t _f			8	12		
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			43	Α	
Pulse Diode Forward Current ^a	I _{SM}				100	_ ^	
Body Diode Voltage	V_{SD}	I _S = 30 A		0.9	1.5	V	
Body Diode Reverse Recovery Time	t _{rr}			30	45	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	L = 20 A di/dt = 100 A/up T = 25 °C		20	30	nC	
Reverse Recovery Fall Time	t _a	$I_F = 20 \text{ A, di/dt} = 100 \text{ A/µs, T}_J = 25 °C$		13.5		no	
Reverse Recovery Rise Time	t _b			16.5		ns	

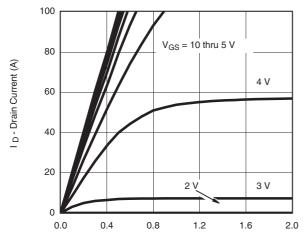
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

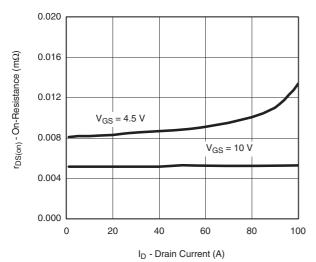


TYPICAL CHARACTERISTICS 25 °C unless noted

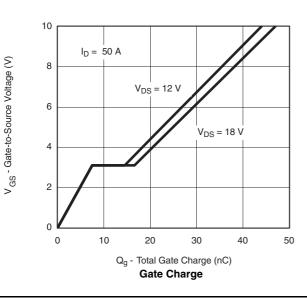


V_{DS} - Drain-to-Source Voltage (V)

Output Characteristics



On-Resistance vs. Drain Current and Gate Voltage



T_C = 125 °C

T_C = 125 °C

1.0

1.5

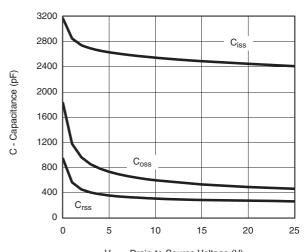
2.0

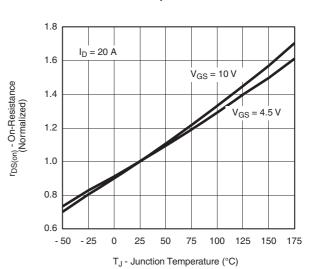
2.5

3.0

3.5

V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**





On-Resistance vs. Junction Temperature

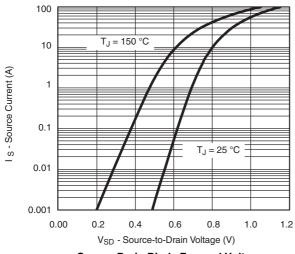
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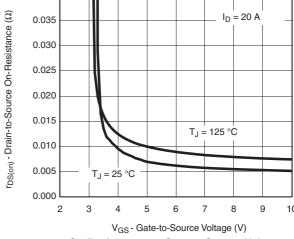
0.040



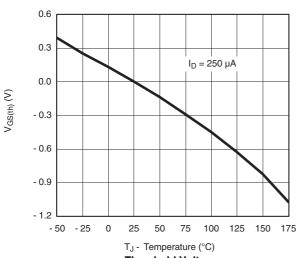
TYPICAL CHARACTERISTICS 25 °C unless noted



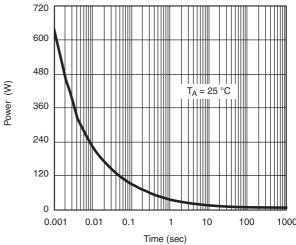
Source-Drain Diode Forward Voltage



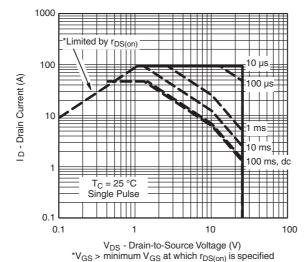
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



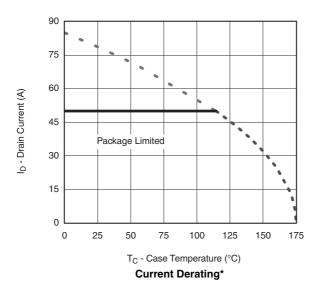
Single Pulse Power, Junction-to-Ambient

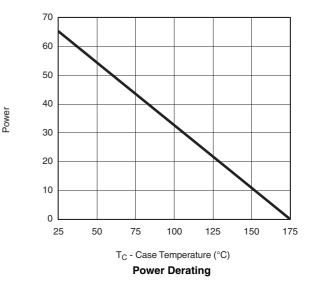


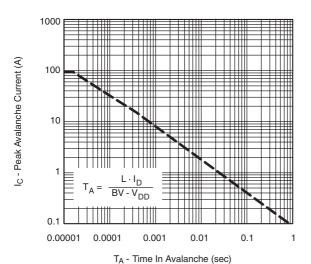
Safe Operating Area, Junction-to-Case



TYPICAL CHARACTERISTICS 25 °C unless noted





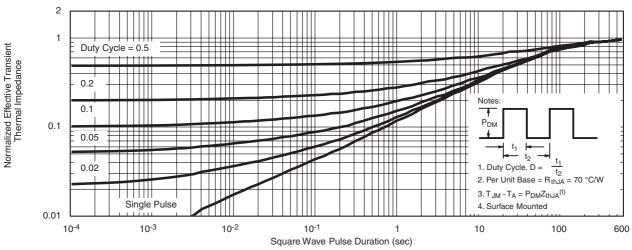


Single Pulse Avalanche Capability

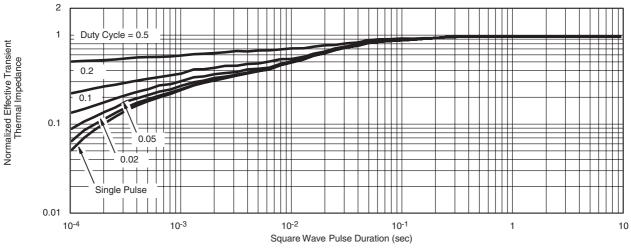
^{*}The power dissipation P_D is based on $T_{J(max)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS 25 °C unless noted

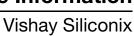


Normalized Thermal Transient Impedance, Junction-to-Ambient



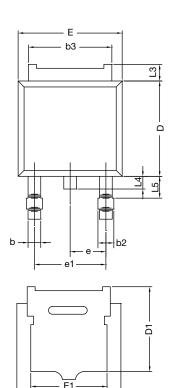
Normalized Thermal Transient Impedance, Junction-to-Case

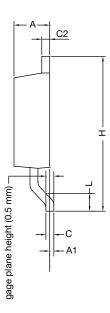
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TO-252AA Case Outline





	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090 BSC		
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16-0236-Rev. P, 16-May-16					

ECN: T16-0236-Rev. P, 16-May-16 DWG: 5347

Notes

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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